



December 03, 2003

CKC Laboratories, Inc.
5473-A Clouds Rest
Mariposa, CA 95338

Re: WindConnect II model differences

Report Department,

This letter is to clarify the differences between the two models of the WindConnect II product. Both models utilize the same Printed Circuit Board (PCB) but certain components are not populated depending on the model. The two models are WindConnect II USB and WindConnect II Parallel.

The basic PCB accommodates circuitry for a 66.00 MHz crystal oscillator, ColdFire Processor, SDRAM and Flash memory, Bluetooth-compliant wireless device with 12.00 MHz crystal and on-board antenna, power supply, two LED's, a parallel port and USB port with 12.00 MHz crystal.

The WindConnect II USB model has all the above mentioned basic circuitry, except the parallel port components are not soldered to the board. These parallel port components include a 100-pin parallel port controller device, a 36-pin Centronics connector, 4 resistor networks, 5 chip resistors and 5 chip capacitors.

The WindConnect II Parallel model has all the above mentioned basic circuitry, except the USB port components are not soldered to the board. These USB port components include a 48-pin USB host controller device, a USB jack, power control switch device, 2 diodes, two small inductors, a 12.00 MHz crystal, 10 chip resistors and 14 chip capacitors.

For both models, the Bluetooth circuitry remains intact and completely unaltered. Both are encased in plastic enclosures using the same base, top and end panel(s).

If you have any further questions or need additional information, please feel free to give me a call at 949-261-4630.

Sincerely,

Ronald Tozaki
Sr. Hardware Engineer